

Maximum Ratings P-Channel (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	ID	-5.1 -4.2	А
Continuous Drain Current (Note 5) V_{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	ID	-4.0 -3.2	А
Maximum Body Diode Continuous Current			Is	-2.0	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 6)		PD	1.2	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{θJA}	102	°C/W
Total Power Dissipation (Note 5)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	78	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics P-Channel (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)					•		
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_		V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current $@T_J = +25^{\circ}C$	I _{DSS}	_	_	-1	μA	$V_{DS} = -24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	-1	-1.7	-2.1	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
Static Drain-Source On-Resistance		-	34	42	mΩ	$V_{GS} = -10V, I_D = -4.9A$	
Static Drain-Source On-Resistance	R _{DS} (ON)	_	52	65		V_{GS} = -4.5V, I_{D} = -3.7A	
Forward Transfer Admittance	Y _{fs}	_	8.5	-	S	$V_{DS} = -5V, I_D = -4.9A$	
Diode Forward Voltage	V _{SD}	_	-0.75	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	587	880		$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	
Output Capacitance	Coss	_	160	240	pF		
Reverse Transfer Capacitance	Crss	_	84	130			
Total Gate Charge (V _{GS} = -4.5V)	Qg		6.3	10			
Total Gate Charge (V _{GS} = -10V)	Qg		12.3	20	nC	V _{DS} = -15V, I _D = -4.9A	
Gate-Source Charge	Qgs		1.9	4	nc		
Gate-Drain Charge	Q _{gd}	_	2.5	5]		
Turn-On Delay Time	t _{D(on)}	_	5.7	10		$V_{DD} = -15V, V_{GS} = -10V,$ $I_D = -4.9A, R_G = 6\Omega$	
Turn-On Rise Time	tr		11.8	22	1		
Turn-Off Delay Time	t _{D(off)}	_	21.8	35	ns		
Turn-Off Fall Time	t _f	_	23.9	40	1		

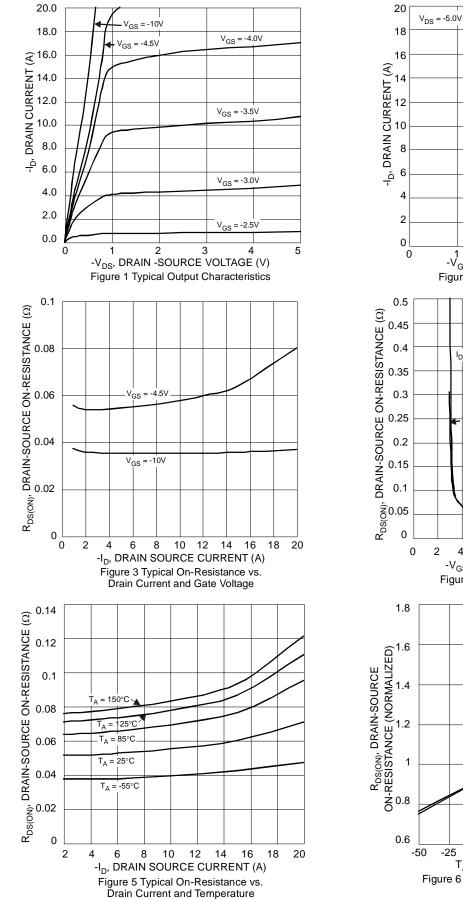
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.







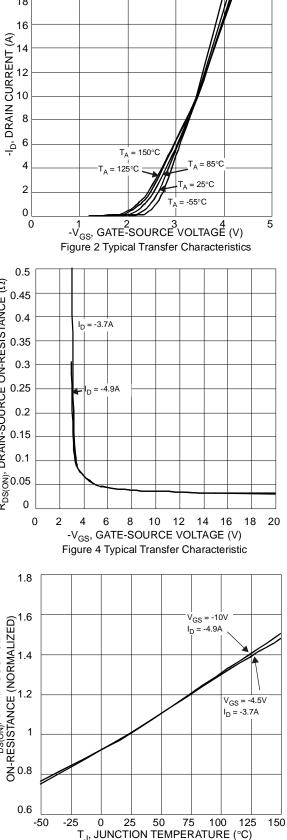
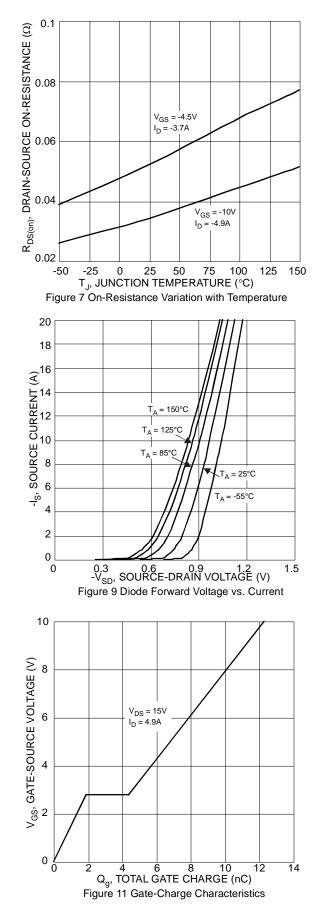
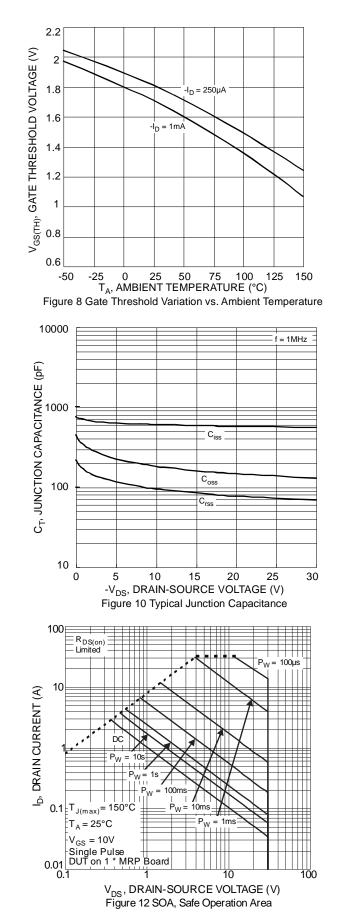


Figure 6 On-Resistance Variation with Temperature

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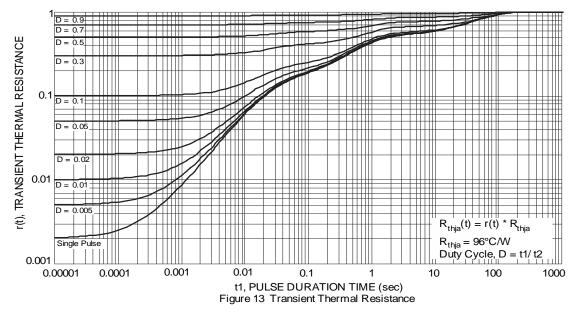






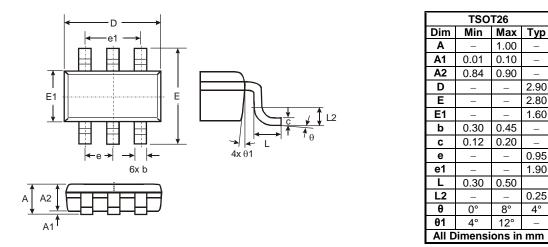
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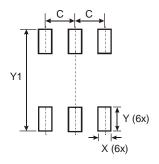
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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